## FEATURES

Output frequency range: $\mathbf{3 0} \mathbf{~ M H z}$ to $\mathbf{2 2 0 0} \mathbf{~ M H z}$
1 dB output compression: 11 dBm at 350 MHz
Noise floor: - $159 \mathrm{dBm} / \mathrm{Hz}$ at 350 MHz
Sideband suppression: $\mathbf{- 5 0 ~ d B c}$ at $\mathbf{3 5 0} \mathbf{~ M H z}$
Carrier feedthrough: - $\mathbf{4 6} \mathbf{~ d B m}$ at 350 MHz
Single supply: 4.75 V to 5.5 V
24-lead, RoHS-compliant, LFCSP with exposed pad

## APPLICATIONS

Radio-link infrastructure
Cable modem termination systems
UHF/VHF radio
Wireless infrastructure systems
Wireless local loop
WiMAX/broadband wireless access systems

## GENERAL DESCRIPTION

The ADL5385 is a silicon, monolithic, quadrature modulator designed for use from 30 MHz to 2200 MHz . Its excellent phase accuracy and amplitude balance enable both high performance intermediate frequency (IF) and direct radio frequency (RF) modulation for communication systems.
The ADL5385 takes the signals from two differential baseband inputs and modulates them onto two carriers in quadrature with each other. The two internal carriers are derived from a single-ended, external local oscillator input signal at twice the frequency as the desired carrier output. The two modulated signals are summed together in a differential-to-single-ended amplifier designed to drive $50 \Omega$ loads.


The ADL5385 can be used as either an IF or a direct-to-RF modulator in digital communication systems. The wide baseband input bandwidth allows for either baseband drive or drive from a complex IF. Typical applications are in radio-link transmitters, cable modem termination systems, and broadband wireless access systems.
The ADL5385 is fabricated using the Analog Devices, Inc., advanced silicon germanium bipolar process and is packaged in a 24 -lead, RoHS-compliant LFCSP with exposed pad. Performance is specified over $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. A RoHS-compliant evaluation board is also available.

Rev. D

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## SPECIFICATIONS

Unless otherwise noted, $\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} ; \mathrm{LO}=-7 \mathrm{dBm} ; \mathrm{I} / \mathrm{Q}$ inputs $=1.4 \mathrm{~V}$ p-p differential sine waves in quadrature on a 500 mV dc bias; baseband frequency $=1 \mathrm{MHz} ; \mathrm{LO}$ source and RF output load impedances are $50 \Omega$.

Table 1.

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OUTPUT FREQUENCY RANGE |  | 30 |  | 2200 | MHz |
| EXTERNAL LO FREQUENCY RANGE | External LO frequency $2 \times$ output frequency | 60 |  | 4400 | MHz |
| OUTPUT FREQUENCY $=30 \mathrm{MHz}$ ( $\mathrm{LO}=0 \mathrm{dBm}$ ) <br> Output Power <br> Output P1dB <br> Carrier Feedthrough <br> Sideband Suppression <br> Second Baseband Harmonic <br> Third Baseband Harmonic <br> Output IP2 <br> Output IP3 <br> Quadrature Phase Error <br> I/Q Amplitude Balance <br> Noise Floor <br> Output Return Loss | Single (lower) sideband output <br> Unadjusted (nominal drive level) <br> $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> Unadjusted (nominal drive level) <br> $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> ( $\mathrm{f}_{\mathrm{LO}}-\left(2 \times \mathrm{f}_{\mathrm{BB}}\right)$ ), Pout $=5 \mathrm{dBm}$ <br> (fio $-\left(2 \times f_{B B}\right)$ ), Pout $=5 \mathrm{dBm}$ <br> F1 $=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone <br> F1 $=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone <br> 20 MHz offset from LO, all BB inputs at a bias of 500 mV 20 MHz offset from LO, output power $=-5 \mathrm{dBm}$ |  | $\begin{aligned} & 4.7 \\ & 11 \\ & -57 \\ & -68 \\ & -65 \\ & -51 \\ & -59 \\ & -60 \\ & -88 \\ & -57 \\ & 76 \\ & 24 \\ & 0.43 \\ & 0.015 \\ & -155 \\ & -150 \\ & -20 \end{aligned}$ |  | dBm <br> dBm <br> dBm <br> dBm <br> dBm <br> dBc <br> $d B c$ <br> dBc <br> dBc <br> dBc <br> dBm <br> dBm <br> Degrees <br> dB <br> $\mathrm{dBm} / \mathrm{Hz}$ <br> $\mathrm{dBm} / \mathrm{Hz}$ <br> dB |
| OUTPUT FREQUENCY $=50 \mathrm{MHz}$ <br> Output Power <br> Output P1 dB <br> Carrier Feedthrough <br> Sideband Suppression <br> Second Baseband Harmonic <br> Third Baseband Harmonic <br> Output IP2 <br> Output IP3 <br> Quadrature Phase Error <br> I/Q Amplitude Balance Noise Floor <br> Output Return Loss | Single (lower) sideband output <br> Unadjusted (nominal drive level) <br> $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> Unadjusted (nominal drive level) <br> $@+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> @ $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $\left(f_{\text {LO }}-\left(2 \times f_{B B}\right)\right)$, Pout $=5 \mathrm{dBm}$ <br> $\left(f_{\mathrm{LO}}+\left(3 \times \mathrm{f}_{\mathrm{BB}}\right)\right)$, Pout $=5 \mathrm{dBm}$ <br> F1 $=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone <br> $\mathrm{F} 1=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, $\mathrm{Pout}=-3 \mathrm{dBm}$ per tone <br> 20 MHz offset from LO, all BB inputs at a bias of 500 mV 20 MHz offset from LO, output power $=-5 \mathrm{dBm}$ | 4 | 5.6 11 -57 -67 -67 -57 -64 -68 -83 -58 69 26 -0.17 -0.03 -155 -150 -19 | 8 | dBm <br> dBm <br> dBm <br> dBm <br> dBm <br> dBc <br> dBC <br> dBC <br> dBc <br> dBc <br> dBm <br> dBm <br> Degrees <br> dB <br> $\mathrm{dBm} / \mathrm{Hz}$ <br> $\mathrm{dBm} / \mathrm{Hz}$ <br> dB |


| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OUTPUT FREQUENCY $=140 \mathrm{MHz}$ |  |  |  |  |  |
| Output Power | Single (lower) sideband output | 5.7 |  |  | dBm |
| Output P1 dB |  | 11 |  |  | dBm |
| Carrier Feedthrough | Unadjusted (nominal drive level) | -52 |  |  | dBm |
|  | $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ | -66 |  |  | dBm |
|  | $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ | -67 |  |  | dBm |
| Sideband Suppression | Unadjusted (nominal drive level) | -53 |  |  | dBC |
|  | $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ | -63 |  |  | dBc |
|  | $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ | -68 |  |  | dBc |
| Second Baseband Harmonic | $\left(\mathrm{f}_{\text {LO }}-\left(2 \times \mathrm{f}_{\mathrm{BB}}\right)\right.$ ), P- Pout $=5 \mathrm{dBm}$ | -83 |  |  | dBc |
| Third Baseband Harmonic | $\left(f_{\text {LO }}+\left(3 \times f_{\text {BB }}\right)\right), \mathrm{P}_{\text {OUT }}=5 \mathrm{dBm}$ | -57 |  |  | dBc |
| Output IP2 | $\mathrm{F} 1=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone | 70 |  |  | dBm |
| Output IP3 | $\mathrm{F} 1=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone | 26 |  |  | dBm |
| Quadrature Phase Error |  | -0.33 |  |  | Degrees |
| I/Q Amplitude Balance |  | -0.03 |  |  | dB |
| Noise Floor | 20 MHz offset from LO, all BB inputs at a bias of 500 mV | -160 |  |  | $\mathrm{dBm} / \mathrm{Hz}$ |
| Output Return Loss |  | -20 |  |  | dB |
| OUTPUT FREQUENCY $=350 \mathrm{MHz}$ |  |  |  |  |  |
| Output Power | Single (lower) sideband output | 3 | 5.6 | 7 | dBm |
| Output P1 dB |  |  | 11 |  | dBm |
| Carrier Feedthrough | Unadjusted (nominal drive level) | -46 |  |  | dBm |
|  | $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ | -65 |  |  | dBm |
|  | $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ | -66 |  |  | dBm |
| Sideband Suppression | Unadjusted (nominal drive level) | -50 |  |  | dBc |
|  | $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ | -63 |  |  | dBc |
|  | $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ | -61 |  |  | dBc |
| Second Baseband Harmonic |  | -80 |  |  | dBc |
| Third Baseband Harmonic | $\left(\mathrm{f}_{\text {LO }}+\left(3 \times \mathrm{f}_{\text {BB }}\right)\right.$ ), P Pout $=5 \mathrm{dBm}$ | -53 |  |  | dBc |
| Output IP2 | $\mathrm{F} 1=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone | 71 |  |  | dBm |
| Output IP3 | $\mathrm{F} 1=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone | 26 |  |  | dBm |
| Quadrature Phase Error |  | 0.39 |  |  | Degrees |
| I/Q Amplitude Balance |  | -0.03 |  |  | dB |
| Noise Floor | 20 MHz offset from LO, all BB inputs at a bias of 500 mV | -159 |  |  | $\mathrm{dBm} / \mathrm{Hz}$ |
|  | 20 MHz offset from LO, output power $=-5 \mathrm{dBm}$ | -157 |  |  | $\mathrm{dBm} / \mathrm{Hz}$ |
| Output Return Loss |  | -21 |  |  | dB |
| OUTPUT FREQUENCY $=860 \mathrm{MHz}$ |  |  |  |  |  |
| Output Power | Single (lower) sideband output | 2.5 | 5.3 | 6.5 | dBm |
| Output P1 dB |  |  | 11 |  | dBm |
| Carrier Feedthrough | Unadjusted (nominal drive level) |  | -41 | -35 | dBm |
|  | $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ |  | -63 |  | dBm |
|  | $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ |  | -65 |  | dBm |
| Sideband Suppression | Unadjusted (nominal drive level) |  | -41 | -35 | dBc |
|  |  |  | -58 |  | dBc |
|  | $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ |  | -59 |  | dBC |
| Second Baseband Harmonic |  |  | -73 | -57 | dBC |
| Third Baseband Harmonic | $\left(\mathrm{f}_{\mathrm{LO}}+\left(3 \times \mathrm{f}_{\text {BB }}\right)\right.$ ), P- $\mathrm{Pout}=5 \mathrm{dBm}$ |  | -50 | -45 | dBC |
| Output IP2 | $\mathrm{F} 1=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone |  | 70 |  | dBm |
| Output IP3 | $\mathrm{F} 1=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone |  | 25 |  | dBm |
| Quadrature Phase Error |  |  | 0.67 |  | Degrees |
| I/Q Amplitude Balance |  |  | -0.03 |  | dB |


| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Noise Floor <br> Output Return Loss | 20 MHz offset from LO, all BB inputs at a bias of 500 mV 20 MHz offset from LO, output power $=-5 \mathrm{dBm}$ |  | $\begin{aligned} & \hline-159 \\ & -157 \\ & -19 \\ & \hline \end{aligned}$ |  | $\mathrm{dBm} / \mathrm{Hz}$ $\mathrm{dBm} / \mathrm{Hz}$ dB |
| OUTPUT FREQUENCY $=1450 \mathrm{MHz}$ <br> Output Power <br> Output P1 dB <br> Carrier Feedthrough <br> Sideband Suppression <br> Second Baseband Harmonic <br> Third Baseband Harmonic <br> Output IP2 <br> Output IP3 <br> Quadrature Phase Error <br> I/Q Amplitude Balance <br> Noise Floor <br> Output Return Loss | Single (lower) sideband output <br> Unadjusted (nominal drive level) <br> $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> Unadjusted (nominal drive level) <br> $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $\left(f_{\mathrm{LO}}-\left(2 \times f_{\text {BB }}\right)\right)$, Pout $=4 \mathrm{dBm}$ <br> $\left(f_{\mathrm{LO}}+\left(3 \times \mathrm{f}_{\text {BB }}\right)\right)$, Pout $=4 \mathrm{dBm}$ <br> F1 $=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone <br> F1 $=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone <br> 20 MHz offset from LO, all BB inputs at a bias of 500 mV |  | $\begin{aligned} & 4.4 \\ & 10 \\ & -36 \\ & -50 \\ & -50 \\ & -44 \\ & -61 \\ & -51 \\ & -64 \\ & -52 \\ & 63 \\ & 24 \\ & 0.42 \\ & -0.02 \\ & -160 \\ & -33 \end{aligned}$ |  | dBm <br> dBm <br> dBm <br> dBm <br> dBm <br> dBc <br> dBc <br> dBc <br> dBC <br> dBc <br> dBm <br> dBm <br> Degrees <br> dB <br> $\mathrm{dBm} / \mathrm{Hz}$ <br> dB |
| OUTPUT FREQUENCY $=1900 \mathrm{MHz}$ <br> Output Power <br> Output P1 dB <br> Carrier Feedthrough <br> Sideband Suppression <br> Second Baseband Harmonic <br> Third Baseband Harmonic <br> Output IP2 <br> Output IP3 <br> Quadrature Phase Error <br> I/Q Amplitude Balance <br> Noise Floor <br> Output Return Loss | Single (lower) sideband output <br> Unadjusted (nominal drive level) <br> $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> Unadjusted (nominal drive level) <br> $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> ( $\mathrm{f}_{\mathrm{LO}}-\left(2 \times \mathrm{f}_{\mathrm{BB}}\right)$ ), Pout $=3 \mathrm{dBm}$ <br> (fio $\left.+\left(3 \times f_{B B}\right)\right)$, Pout $=3 \mathrm{dBm}$ <br> $\mathrm{F} 1=+3.5 \mathrm{MHz}, \mathrm{F} 2=+4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone <br> $\mathrm{F} 1=+3.5 \mathrm{MHz}, \mathrm{F} 2=+4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone <br> 20 MHz offset from LO, all BB inputs at a bias of 500 mV 20 MHz offset from LO, output power $=-5 \mathrm{dBm}$ |  | $\begin{aligned} & 3.4 \\ & 9 \\ & -35 \\ & -51 \\ & -51 \\ & -33 \\ & -43 \\ & -47 \\ & -58 \\ & -47 \\ & 57 \\ & 22 \\ & 2.6 \\ & 0.003 \\ & -160 \\ & -156 \\ & -20 \end{aligned}$ |  | dBm <br> dBm <br> dBm <br> dBm <br> dBm <br> dBC <br> dBc <br> dBc <br> dBc <br> dBc <br> dBm <br> dBm <br> Degrees <br> dB <br> $\mathrm{dBm} / \mathrm{Hz}$ <br> $\mathrm{dBm} / \mathrm{Hz}$ <br> dB |
| ```OUTPUT FREQUENCY \(=2150 \mathrm{MHz}\) Output Power Output P1 dB Carrier Feedthrough Sideband Suppression Second Baseband Harmonic Third Baseband Harmonic Output IP2 Output IP3 Quadrature Phase Error I/Q Amplitude Balance``` | Single (lower) sideband output <br> Unadjusted (nominal drive level) <br> $+85^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> $-40^{\circ} \mathrm{C}$ after optimization at $+25^{\circ} \mathrm{C}$ <br> Unadjusted (nominal drive level) <br> ( $\mathrm{f}_{\mathrm{LO}}-\left(2 \times \mathrm{f}_{\mathrm{BB}}\right)$ ), Pout $=2.6 \mathrm{dBm}$ <br> $\left(f_{\text {LO }}+\left(3 \times f_{B B}\right)\right)$, Pout $=2.6 \mathrm{dBm}$ <br> $\mathrm{F} 1=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone <br> F1 $=3.5 \mathrm{MHz}, \mathrm{F} 2=4.5 \mathrm{MHz}$, Pout $=-3 \mathrm{dBm}$ per tone |  | $\begin{aligned} & 2.6 \\ & 8 \\ & -36 \\ & -47 \\ & -48 \\ & -37 \\ & -56 \\ & -45 \\ & 54 \\ & 21 \\ & 1.5 \\ & <0.05 \end{aligned}$ |  | dBm <br> dBm <br> dBm <br> dBm <br> dBm <br> dBc <br> dBc <br> dBc <br> dBm <br> dBm <br> Degrees <br> dB |

## ADL5385

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Noise Floor <br> Output Return Loss | 20 MHz offset from LO, all BB inputs at a bias of 500 mV <br> 20 MHz offset from LO, output power $=-5 \mathrm{dBm}$ |  | $\begin{aligned} & \hline-160 \\ & -156 \\ & -15 \\ & \hline \end{aligned}$ |  | $\mathrm{dBm} / \mathrm{Hz}$ $\mathrm{dBm} / \mathrm{Hz}$ dB |
| LO INPUTS LO Drive Level Input Impedance Input Return Loss | Pin LOIP and Pin LOIN <br> Characterization performed at typical level $\text { fout }<50 \mathrm{MHz}$ <br> 350 MHz , LOIN ac-coupled to ground |  | $\begin{aligned} & -7 \\ & 0 \\ & 50 \\ & -20 \end{aligned}$ | $\begin{aligned} & +5 \\ & 5 \end{aligned}$ | dBm <br> dBm <br> $\Omega$ <br> dB |
| BASEBAND INPUTS I and Q Input Bias Level Input Bias Current Bandwidth ( 0.1 dB ) Bandwidth (3 dB) | Pin IBBP, Pin IBBN, Pin QBBP, Pin QBBN $\begin{aligned} & \mathrm{RF}=500 \mathrm{MHz} \text {, output power }=0 \mathrm{dBm} \\ & \mathrm{RF}=500 \mathrm{MHz} \text {, output power }=0 \mathrm{dBm} \end{aligned}$ |  | $\begin{aligned} & 500 \\ & -70 \\ & 80 \\ & >500 \end{aligned}$ |  | mV <br> $\mu \mathrm{A}$ <br> MHz <br> MHz |
| ENABLE INPUT <br> Turn-On Settling Time Turn-Off Settling Time ENBL High Level (Logic 1) ENBL Low Level (Logic 0) | ENBL <br> ENBL = high (for output to within 0.5 dB of final value) <br> ENBL = low (at supply current falling below 20 mA ) | 1.5 | $\begin{aligned} & 1.0 \\ & 1.4 \end{aligned}$ | 0.4 | $\begin{aligned} & \mu \mathrm{s} \\ & \mu \mathrm{~s} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| TEMPERATURE OUTPUT <br> Output Voltage Temperature Slope Output Impedance | TEMP $\begin{aligned} & T_{A}=27.15^{\circ} \mathrm{C}, 300.3 \mathrm{~K}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega \text { (after full warm up) } \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega \end{aligned}$ |  | $\begin{aligned} & 1.56 \\ & 4.6 \\ & 1.0 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} /{ }^{\circ} \mathrm{C} \\ & \mathrm{k} \Omega \end{aligned}$ |
| POWER SUPPLIES Voltage Supply Current | Pin VPS1 and Pin VPS2 $\begin{aligned} & \text { ENBL }=\text { high } \\ & \text { ENBL }=\text { low } \end{aligned}$ | 4.75 | $\begin{aligned} & 215 \\ & 80 \end{aligned}$ | 5.5 240 | V <br> mA <br> $\mu \mathrm{A}$ |

## ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter | Rating |
| :--- | :--- |
| Supply Voltage VPOS | 5.5 V |
| IBBP, IBBN, QBBP, QBBN Range | 0 V to 2.0 V |
| LOIP and LOIN | 13 dBm |
| Internal Power Dissipation | 1.375 W |
| ӨJA (Exposed Pad Soldered Down) $_{\text {Maximum Junction Temperature }}$ | $58^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating Temperature Range | $164^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## ESD CAUTION

|  | ESD (electrostatic discharge) sensitive device. <br> Charged devices and circuit boards can discharge <br> without detection. Although this product features <br> patented or proprietary protection circuitry, damage <br> may occur on devices subjected to high energy ESD. <br> Therefore, proper ESD precautions should be taken to <br> avoid performance degradation or loss of functionality. |
| :--- | :--- |

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :--- | :--- | :--- |
| $1,2,3$ | NC | No Connect. Leave these pins open or tie them to ground. |
| $4,5,6,15$, | COM1, COM2, | Power Supply Common Pins. Connect COM1, COM2, and COM3 to a ground plane via a low impedance path. |
| $16,19,20$ | COM3 |  |
| 7 | VOUT | Device Output. Single-ended, $50 \Omega$ internally biased RF/IF output; pin must be ac-coupled to the load. |
| $8,9,11,23$, | VPS1, VPS2, | Power Supply Pins. Decouple each pin with a $0.1 \mu \mathrm{~F}$ capacitor; Pin 8 and Pin 9 can share a single capacitor, |
| 24 | VPS3 | as can Pin 23 and Pin 24. Connect all pins to the same supply. |
| 10 | TEMP | Temperature Sensor Output. Provides dc voltage proportional to die temperature. Slope is $4.6 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| 12 | ENBL | Device Enable. Shuts device down when grounded and enables device when pulled to supply voltage. |
| 13,14, | IBBP, IBBN, | Differential In-Phase and Quadrature Baseband Inputs. These high impedance inputs must be externally dc- <br> biased to 500 mV dc and driven from a low impedance source. Nominal characterized ac signal swing is 700 mV |
| 17,18 | QBBN, QBBP | p-p on each pin (150 mV to 850 mV ). This results in a differential drive of 1.4 V p-p with a 500 mV dc bias. <br> 21 |
| Single-Ended Two-Times Local Oscillator Input. This input is internally biased and must be ac-coupled to |  |  |
| 22 | LOIP | the LO source. |

## TYPICAL PERFORMANCE CHARACTERISTICS

Unless otherwise noted, $\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} ; \mathrm{LO}=-7 \mathrm{dBm} ; \mathrm{I} / \mathrm{Q}$ inputs $=1.4 \mathrm{~V}$ p-p differential sine waves in quadrature on a 500 mV dc bias; baseband frequency $=1 \mathrm{MHz}$; LO source and RF output load impedances are $50 \Omega$.


Figure 3. Single Sideband (SSB) Output Power (Pout) vs. Output Frequency and Power Supply


Figure 4. Single Sideband (SSB) Output Power (Pout) vs. Output Frequency and Temperature


Figure 5. Baseband Frequency Response Normalized to Response for 1 MHz BB Signal; Carrier Frequency $=500 \mathrm{MHz}$


Figure 6. Output $1 d B$ Compression Point (OP1dB) vs. Output Frequency and Power Supply


Figure 7. Output $1 d B$ Compression Point (OP1dB) vs. Output Frequency and Temperature


Figure 8. SSB Output Power, Second- and Third-Order Distortion, Carrier Feedthrough, and Sideband Suppression vs. Output Frequency; LO Amplitude $=0 \mathrm{dBm}$


Figure 9. SSB Output Power, Second- and Third-Order Distortion, Carrier Feedthrough, and Sideband Suppression vs. LO Amplitude; Output Frequency $=30 \mathrm{MHz}$


Figure 10. SSB Output Power, Second- and Third-Order Distortion, Carrier Feedthrough and Sideband Suppression vs. Differential Baseband Input Level; Output Frequency $=350 \mathrm{MHz}$


Figure 11. SSB Output Power, Second- and Third-Order Distortion, Carrier Feedthrough and Sideband Suppression vs. Baseband SingleEnded Input Level; Output Frequency $=860$ MHz


Figure 12. Sideband Suppression vs. Output Frequency and Temperature


Figure 13. Sideband Suppression vs. Baseband Frequency; Output Frequency $=350 \mathrm{MHz}$


Figure 14. Distribution of Peak Q Amplitude to Null Undesired Sideband (Peak I Amplitude Held Constant at 0.7 V)


Figure 15. Distribution of IQ Phase to Null Undesired Sideband


Figure 16. Sideband Suppression Distribution at Temperature Extremes, After Sideband Suppression Nulled to $<-50 \mathrm{dBc}$ at $T_{A}=+25^{\circ} \mathrm{C}$


Figure 17. Distribution of Sideband Suppression vs. LO Input Power at $30 \mathrm{MHz}, 50 \mathrm{MHz}$, and 350 MHz Output Frequencies


Figure 18. Distribution Carrier Feedthrough vs. Output Frequency and Temperature


Figure 19. Carrier Feedthrough Distribution at Temperature Extremes, After Nulling to $<-65 \mathrm{dBm}$ at $T_{A}=+25^{\circ} \mathrm{C}$


Figure 20. Distribution of I and Q Offset Required to Null Carrier Feedthrough


Figure 21. Distribution Carrier Feedthrough vs. LO Input Power at $30 \mathrm{MHz}, 50 \mathrm{MHz}$, and 350 MHz Output Frequencies


Figure 22. OIP3 and OIP2 vs. Output Frequency and Temperature


Figure 23. 20 MHz Offset Noise Floor Distribution, Output Frequency $=350 \mathrm{MHz}$, Pout $=-5 \mathrm{dBm}$, QPSK Carrier, Symbol Rate $=3.84 \mathrm{MSPS}$


Figure 24. 12 MHz Offset Noise Floor Distribution,
Output Frequency $=860 \mathrm{MHz}$, Pout $=-5 \mathrm{dBm}, 64$ QAM Carrier,
Symbol Rate $=5$ MSPS


Figure 25. LO Port Input Return Loss vs. Frequency


Figure 26. Output Impedance and LO Input Impedance vs. Frequency


Figure 27. Power Supply Current vs. Temperature and Supply Voltage

## CIRCUIT DESCRIPTION

## OVERVIEW

The ADL5385 can be divided into five sections: the local oscillator (LO) interface, the baseband voltage-to-current (V-to-I) converter, the mixers, the differential-to-single-ended (D-to-S) amplifier, and the bias circuit. A detailed block diagram of the device is shown in Figure 28.


Figure 28. ADL5385 Block Diagram
The LO interface generates two LO signals at $90^{\circ}$ of phase difference to drive two mixers in quadrature. Baseband signals are converted into currents by the V-to-I converters that feed into the two mixers. The outputs of the mixers are combined in the differential-to-single-ended amplifier, which provides a $50 \Omega$ output interface. Reference currents to each section are generated by the bias circuit. A detailed description of each section follows.

## LO INTERFACE

The LO interface consists of a buffer amplifier followed by a pair of frequency dividers that generate two carriers at half the input frequency and in quadrature with each other. Each carrier is then amplified and amplitude-limited to drive the doublebalanced mixers.

## V-TO-I CONVERTER

The differential baseband input voltages that are applied to the baseband input pins are fed to a pair of common-emitter, voltage-to-current converters. The output currents then modulate the two half-frequency LO carriers in the mixer stage.

## MIXERS

The ADL5385 has two double-balanced mixers: one for the inphase channel (I channel) and one for the quadrature channel ( Q channel). These mixers are based on the Gilbert cell design of four cross-connected transistors. The output currents from the two mixers are summed together in the resistor-inductor (RL) loads in the D-to-S amplifier.

## D-TO-S AMPLIFIER

The output D-to-S amplifier consists of two emitter followers driving a totem-pole output stage that converts the differential signal to a single-ended signal. Output impedance is established by the emitter resistors in the output transistors. The output of this stage connects to the output (VOUT) pin.

## BIAS CIRCUIT

A band gap reference circuit generates the proportional-to-absolute-temperature (PTAT) as well as temperature-independent reference currents used by different sections. The band-gap circuit is turned on by a logic high at the ENBL pin, which in turn powers up the whole device. A PTAT voltage output is available at the TEMP pin, which can be used for temperature monitoring as well as for temperature compensation purposes.

## BASIC CONNECTIONS

Figure 29 shows the basic connections for the ADL5385.

## POWER SUPPLY AND GROUNDING

All the VPS pins must be connected to the same 5 V source. Adjacent pins of the same name can be tied together and decoupled with a $0.1 \mu \mathrm{~F}$ capacitor. Locate these capacitors as close as possible to the device. The power supply can range from 4.75 V to 5.5 V .

The COM1 pin, COM2 pin, and COM3 pin are tied to the same ground plane through low impedance paths. The exposed pad on the underside of the package is also soldered to a low thermal and electrical impedance ground plane. If the ground plane spans multiple layers on the circuit board, stitch the layers together with nine vias under the exposed pad. The Analog Devices AN-722 Application Note discusses the thermal and electrical grounding of the LFCSP in greater detail.

## BASEBAND INPUTS

The baseband inputs QBBP, QBBN, IBBP, and IBBN must be driven from a differential source. The nominal drive level of 1.4 V p-p differential ( 700 mV p-p on each pin) is biased to a common-mode level of 500 mV dc .

The dc common-mode bias level for the baseband inputs can range from 400 mV to 600 mV . This results in a reduction in the usable input ac swing range. The nominal dc bias of 500 mV allows for the largest ac swing, limited on the bottom end by the ADL5385 input range and on the top end by the output compliance range on most Analog Devices DACs.


Figure 29. Basic Connections for the ADL5385

## OPTIMIZATION

The carrier feedthrough and sideband suppression performance of the ADL5385 can be improved through the use of optimization techniques.

## Carrier Feedthrough Nulling

Carrier feedthrough results from minute dc offsets that occur between each of the differential baseband inputs. In an ideal modulator, the quantities $\left(\mathrm{V}_{\text {IOPP }}-\mathrm{V}_{\text {IOPN }}\right)$ and $\left(\mathrm{V}_{\text {QOPP }}-\mathrm{V}_{\text {QOPN }}\right)$ are equal to zero, and this results in no carrier feedthrough. In a real modulator, those two quantities are nonzero and, when mixed with the LO, result in a finite amount of carrier feedthrough. The ADL5385 is designed to provide a minimal amount of carrier feedthrough. If even lower carrier feedthrough levels are required, minor adjustments can be made to the $\left(\mathrm{V}_{\text {IOPP }}-\mathrm{V}_{\text {IOPN }}\right)$ and $\left(\mathrm{V}_{\text {QOPP }}-\right.$ $\mathrm{V}_{\mathrm{QopN}}$ ) offsets. The I-channel offset is held constant while the Q-channel offset is varied until a minimum carrier feedthrough level is obtained. The Q-channel offset required to achieve this minimum is held constant while the offset on the I-channel is adjusted, until a better minimum is reached. Through two iterations of this process, the carrier feedthrough can be reduced to as low as the output noise. The ability to null is sometimes limited by the resolution of the offset adjustment. Figure 30 shows the relationship of carrier feedthrough vs. dc offset.


Figure 30. Carrier Feedthrough vs. DC Offset Voltage at 450 MHz
Note that throughout the nulling process, the dc bias for the baseband inputs remains at 500 mV . When no offset is applied,

$$
\begin{aligned}
& V_{I O P P}=V_{I O P N}=500 \mathrm{mV}, \text { or } \\
& V_{I O P P}-V_{I O P N}=V_{I O S}=0 \mathrm{~V}
\end{aligned}
$$

When an offset of $+\mathrm{V}_{\text {Ios }}$ is applied to the I-channel inputs,

$$
\begin{aligned}
& V_{I O P P}=500 \mathrm{mV}+V_{I O S} / 2, \text { while } \\
& V_{\text {IOPN }}=500 \mathrm{mV}-V_{I O S} / 2, \text { such that } \\
& V_{\text {IOPP }}-V_{I O P N}=V_{I O S}
\end{aligned}
$$

The same applies to the Q channel.

It is often desirable to perform a one-time carrier null calibration. This is usually performed at a single frequency. Figure 31 shows how carrier feedthrough varies with LO frequency over a range of $\pm 50 \mathrm{MHz}$ on either side of a null at 350 MHz .


Figure 31. Carrier Feedthrough vs. Frequency After Nulling at 350 MHz

## Sideband Suppression Optimization

Sideband suppression results from relative gain and relative phase offsets between the I and Q channels and can be suppressed through adjustments to those two parameters. Figure 32 illustrates how sideband suppression is affected by the gain and phase imbalances.


Figure 32. Sideband Suppression vs. Quadrature Phase Error for Various Quadrature Amplitude Offsets
Figure 32 underscores the fact that adjusting one parameter improves the sideband suppression only to a point; the other parameter must also be adjusted. For example, if the amplitude offset is 0.25 dB , improving the phase imbalance better than $1^{\circ}$ does not yield any improvement in the sideband suppression. For optimum sideband suppression, an iterative adjustment between phase and amplitude is required.
The sideband suppression nulling can be performed either through adjusting the gain for each channel or through the modification of the phase and gain of the digital data coming from the digital signal processor.

## APPLICATIONS INFORMATION

## DAC MODULATOR INTERFACING

The ADL5385 is designed to interface with minimal components to members of the Analog Devices family of digital-to-analog converters (DAC). These DACs feature an output current swing from 0 mA to 20 mA , and the interface described in this section can be used with any DAC that has a similar output.

## Driving the ADL5385 with an Analog Devices TxDAC ${ }^{\oplus}$

An example of the interface using the AD9777 TxDAC is shown in Figure 33. The baseband inputs of the ADL5385 require a dc bias of 500 mV . The average output current on each of the outputs of the AD9777 is 10 mA . Therefore, a single $50 \Omega$ resistor to ground from each of the DAC outputs results in an average current of 10 mA flowing through each of the resistors, thus producing the desired 500 mV dc bias for the inputs to the ADL5385.


Figure 33. Interface Between AD9777 and ADL5385 with $50 \Omega$ Resistors to Ground to Establish the 500 mV DC Bias for the ADL5385 Baseband Inputs

The AD9777 output currents have a swing that ranges from 0 mA to 20 mA . With the $50 \Omega$ resistors in place, the ac voltage swing going into the ADL5385 baseband inputs ranges from 0 V to 1 V . A full-scale sine wave out of the AD9777 can be described as a 1 V p-p single-ended (or 2 V p-p differential) sine wave with a 500 mV dc bias.

## Limiting the AC Swing

There are situations in which it is desirable to reduce the ac voltage swing for a given DAC output current. This can be achieved through the addition of another resistor to the interface. This resistor is placed in shunt between each side of the differential pair, as illustrated in Figure 34. It has the effect of reducing the ac swing without changing the dc bias already established by the $50 \Omega$ resistors.


Figure 34. AC Voltage Swing Reduction Through Introduction of Shunt Resistor Between Differential Pair

The value of this ac voltage swing limiting resistor is chosen based on the desired ac voltage swing. Figure 35 shows the relationship between the swing-limiting resistor and the peak-to-peak ac swing that it produces when $50 \Omega$ bias setting resistors are used.


Figure 35. Relationship Between AC Swing Limiting Resistor and Peak-to-Peak Voltage Swing with $50 \Omega$ Bias Setting Resistors

## Filtering

When driving a modulator from a DAC, it is necessary to introduce a low-pass filter between the DAC and the modulator to reduce the DAC images. The interface for setting up the biasing and ac swing lends itself well to the introduction of such a filter. The filter can be inserted in between the dc bias setting resistors and the ac swing-limiting resistor, thus establishing the input and output impedances for the filter.

Examples of filters are discussed in the 155 Mbps (STM-1) 128 QAM Transmitter section and the CMTS Transmitter Application section.

## Using AD9777 Auxiliary DAC for Carrier Feedthrough Nulling

The AD9777 features an auxiliary DAC that can be used to inject small currents into the differential outputs for each channel. The auxiliary DAC can produce the small offset currents necessary to implement the nulling described in the Carrier Feedthrough Nulling section.

## 155 Mbps (STM-1) 128 QAM TRANSMITTER

Figure 39 shows how the ADL5385 can be interfaced to the AD9777 DAC (or any Analog Devices dual DAC with an output bias level of 0.5 V ) to generate a 155 Mbps 128 QAM carrier at 355 MHz . Because the TxDAC output and the IQ modulator inputs operate at the same bias levels of 0.5 V , a simple dccoupled connection can be implemented without any active or passive level shifting. The bias level and modulator drive level is set by the $50 \Omega$ ground-referenced resistors and the $100 \Omega$ shunt resistors, respectively (see the DAC Modulator Interfacing section). A baseband filter is placed between the bias and signal swing resistors. This 5-pole Chebychev filter with in-band ripple of 0.1 dB has a corner frequency of 39 MHz .
Figure 36 shows a spectral plot of the 128 QAM spectrum at a carrier power of -6.3 dBm . Figure 37 shows how EVM (measured with the analyzer's internal equalizer both on and off) and SNR, measured at 55 MHz carrier offset ( 2.5 times the carrier bandwidth) varies with output power.


Figure 36. Spectral Plot of 128 QAM Transmitter at -6.3 dBm Output Power


Figure 37. EVM and SNR vs. Output Power for 128 QAM Transmitter Application

## CMTS TRANSMITTER APPLICATION

Because of its broadband operating range from 30 MHz to 2200 MHz , the ADL5385 can be used in direct-launch cable modem termination systems (CMTS) applications in the 50 MHz to 860 MHz cable band.

The same DAC and DAC-to-modulator interface and filtering circuit shown in Figure 39 was used in this application. Figure 38 shows a plot of a 4-carrier 256 QAM spectrum at an output frequency of 485 MHz .


Figure 38. Spectrum of 4-Carrier 256 QAM CMTS Signal at 485 MHz


Figure 39. Recommended DAC-Modulator Interconnect for128 QAM Transmitter

Figure 40 shows how adjacent channel power (measured at $750 \mathrm{kHz}, 5.25 \mathrm{MHz}$, and 12 MHz offset from the last carrier) and modulation error ratio (MER) vary with carrier power.


Figure 40. ACP1, ACP2, ACP3, and Modulation Error Ratio (MER) vs. Output Power for 256 QAM Transmitter

## SPECTRAL PRODUCTS FROM HARMONIC MIXING

For broadband applications such as cable TV head-end modulators, special attention must be paid to harmonics of the LO. Figure 41 shows the level of these harmonics (out to 3 GHz ) as a function of the output frequency from 50 MHz to 1000 MHz , in a single-sideband (SSB) test configuration, with a baseband signal of 1 MHz and a SSB level of approximately -5 dBm . To read this plot correctly, first pick the output frequency of interest on the trace called Pout. The associated harmonics can be read off the harmonic traces at multiples of this frequency. For example, at an output frequency of 500 MHz , the fundamental power is -5 dBm . The power of the second $\left(\mathrm{P}_{2 \mathrm{fc}-\mathrm{BB}}\right)$ and third $\left(\mathrm{P}_{3 \mathrm{f}+\mathrm{BB}}\right)$ harmonics is -63 dBm (at 1000 MHz ) and -16 dBm (at 1500 MHz ), respectively. Of particular importance are the products from odd-harmonics of the LO, generated from the switching operation in the mixers.
For cable TV operation at frequencies above approximately 500 MHz , these harmonics fall out of the band and can be filtered by a fixed filter. However, as the frequency drops below 500 MHz , these harmonics start to fall close to or inside the cable band. This calls for either limitation of the frequency range to above 500 MHz or the use of a switchable filter bank to block in-band harmonics at low frequencies.


Figure 41. Spectral Components for Output Frequencies from 50 MHz to 1000 MHz

## RF SECOND-ORDER PRODUCTS

A two-tone RF output signal produces second-order spectral components at sum and difference frequencies. In broadband systems, these intermodulation products fall inside the carrier or in the adjacent channels. Output second-order RF intermodulation intercept is defined as

$$
\text { OIP2_RF }=P_{\text {OUT }}+\left(P_{\text {OUT }}-P_{I M(R F)}\right)
$$

where $P_{I M(R F)}$ is the level of the intermodulation product at foutı + fout2. OIP2_RF levels from a two-tone test are plotted as a function of carrier frequency in Figure 42, where the baseband tones are 3.5 MHz and 4.5 MHz at -5 dBm each.


Figure 42. Output Second-Order Intermodulation vs. Carrier Frequency

## ADL5385

## LO GENERATION USING PLLs

Analog Devices has a line of phase-locked loops (PLLs) that can be used for generating the LO signal. Table 4 lists the PLLs together with their maximum frequency and phase noise performance.

Table 4. PLL Selection Table

|  | Arequency $\mathbf{f i N}_{\mathbf{N}}(\mathbf{M H z})$ | At $\mathbf{1} \mathbf{~ k H z}$ Phase Noise <br> $\mathbf{d B c} / \mathbf{H z} \mathbf{2 0 0} \mathbf{~ k H z ~ P F D ~}$ |
| :--- | :--- | :--- |
| Device | Fr4110 | 550 |
| -91 at 540 MHz |  |  |
| ADF4111 | 1200 | -87 at 900 MHz |
| ADF4112 | 3000 | -90 at 900 MHz |
| ADF4113 | 4000 | -91 at 900 MHz |
| ADF4116 | 550 | -89 at 540 MHz |
| ADF4117 | 1200 | -87 at 900 MHz |
| ADF4118 | 3000 | -90 at 900 MHz |

The ADF4360-0 through the ADF4360-8 (see Table 5 for the full list of devices included in this range) come as a family of chips, with nine operating frequency ranges. One device can be chosen depending on the local oscillator frequency required. While the use of the integrated synthesizer might come at the expense of slightly degraded noise performance from the ADL5385, it can be a cheaper alternative to a separate PLL and VCO solution. Alternatively, the ADF4351 can be used, which covers a frequency range of 35 MHz to 4400 MHz .
Table 5 shows the options available.
Table 5. PLL/VCO Family Operating Frequencies

| Device | Output Frequency Range (MHz) |
| :--- | :--- |
| ADF4351 | 35 to 4400 |
| ADF4360-0 | 2400 to 2725 |
| ADF4360-1 | 2050 to 2450 |
| ADF4360-2 | 1850 to 2150 |
| ADF4360-3 | 1600 to 1950 |
| ADF4360-4 | 1450 to 1750 |
| ADF4360-5 | 1200 to 1400 |
| ADF4360-6 | 1050 to 1250 |
| ADF4360-7 | 350 to 1800 |
| ADF4360-8 | 65 to 400 |

## TRANSMIT DAC OPTIONS

The AD9777 recommended in the previous sections is by no means the only DAC that can be used to drive the ADL5385. There are other appropriate DACs depending on the level of performance required. Table 6 lists the dual TxDACs that Analog Devices offers.

Table 6. Dual TxDAC Selection Table

| Device | Resolution (Bits) | Update Rate (MSPS Minimum) |
| :--- | :--- | :--- |
| AD9709 | 8 | 125 |
| AD9761 | 10 | 40 |
| AD9763 | 10 | 125 |
| AD9765 | 12 | 125 |
| AD9767 | 14 | 125 |
| AD9773 | 12 | 160 |
| AD9775 | 14 | 160 |
| AD9777 | 16 | 160 |
| AD9776 | 12 | 1000 |
| AD9778 | 14 | 1000 |
| AD9779 | 16 | 1000 |
| AD9122 | 16 | 1200 |

All DACs listed have nominal bias levels of 0.5 V and use the same DAC-modulator interface shown in Figure 33.

## MODULATOR/DEMODULATOR OPTIONS

Table 7 lists other Analog Devices discrete modulators and demodulators.

Table 7. Modulator/Demodulator Options

| Device | Mod/Demod | Frequency <br> Range (MHz) | Comments |
| :--- | :--- | :--- | :--- |
| AD8345 | Mod | 140 to 1000 |  |
| AD8346 | Mod | 800 to 2500 |  |
| AD8349 | Mod | 700 to 2700 |  |
| ADL5390 | Mod | 20 to 2400 | External |
|  |  |  | quadrature |
| ADL5370 | Mod | 300 to 1000 |  |
| ADL5371 | Mod | 500 to 1500 |  |
| ADL5372 | Mod | 1500 to 2500 |  |
| ADL5373 | Mod | 2300 to 3000 |  |
| ADL5375 | Mod | 400 to 6000 |  |
| ADL5386 | Mod | 50 to 2200 | Includes VVA |
|  |  |  | and AGC |
| AD8347 | Demod | 800 to 2700 |  |
| AD8348 | Demod | 50 to 1000 |  |
| ADL5380 | Demod | 400 to 6000 |  |
| ADL5382 | Demod | 700 to 2700 |  |
| ADL5387 | Demod | 30 to 2000 |  |
| AD8340 | Vector mod | 700 to 1000 |  |
| AD8341 | Vector mod | 1500 to 2400 |  |

## EVALUATION BOARD

One populated, RoHS-compliant ADL5385 evaluation board is available, the ADL5385-DIFFLO-EBZ. The ADL5385-DIFFLOEBZ can be configured to allow a differential LO drive through a balun or direct interfacing to a PLL evaluation board. It also includes component pads in its LO path to accommodate a harmonic filter. The four baseband inputs are located on one edge of the board to allow direct connection to a high speed DAC evaluation board. The ADL5385-DIFFLO-EBZ also includes an RF/IF amplifier.

The modulator output can be measured directly at the RF_OUT SMA connector. Alternatively, by removing R40, and installing a $0 \Omega$ resistor in the R25 pad, the modulator output can be fed to the RF amplifier.
The ADL5385-DIFFLO-EBZ ships installed with an ADL5601 amplifier ( 50 MHz to 4000 MHz RF/IF amplifier). The ADL5602 can be used if more gain is needed. Figure 43, Table 8, Figure 44, and Figure 45 show the schematic, configuration options, and layouts for the ADL5385-DIFFLO-EBZ, respectively.


Figure 43. ADL5385-DIFFLO-EBZ Schematic
Table 8. ADL5385-DIFFLO-EBZ Configuration Options

| Component | Description | Default Value |
| :---: | :---: | :---: |
| VP1,VPOS_AMP, GND1, GND2 | Power supply clip leads, and ground clip leads. | $\begin{aligned} & \text { Red }(\text { VP1 })=5 \mathrm{~V} \text {, red }(\text { VPOS_AMP })=\text { GND, GND1 } \\ & \text { and GND2 }=\text { black } \end{aligned}$ |
| GND |  | Not applicable |
| S1, R61, R62 | Device enable select. Set S1 to VP to enable the device. Set S1 to GND to power down the device. | $\mathrm{S} 1=\mathrm{on}, \mathrm{R} 61=10 \mathrm{k} \Omega, \mathrm{R} 62=49.9 \Omega$ |
| R1, R2, R3, R4, R6, R17, R33, R36, C41, C75 to C91 | Baseband input filters. These components can be used to implement a low-pass filter for the baseband signals. | $R 1, R 2, R 3, R 4, R 6, R 17, R 33, R 36=0 \Omega$, C41, C75 to C91 = open |
| C14, C15 | LO driving capacitor. | $\mathrm{C} 14, \mathrm{C} 15=0.1 \mu \mathrm{~F}$ |
| R15, R32, R34, C16 to C18, C40 | LO input filters. These components can be used to implement a filter for the LO input signals. | $\begin{aligned} & \text { R15, R32 = open, R34, C40 }=0 \Omega, \\ & \text { C16 to C18 = open } \end{aligned}$ |


| Component | Description | Default Value |
| :---: | :---: | :---: |
| LO_IP SMA, R10, R11, R13, R15, R32, R34, R43, C40, T1, T2 | Single-ended LO input at LOIP. | $\begin{aligned} & \text { R11, R13, R34, R43, C40 }=0 \Omega \text {, } \\ & \text { R10, R15, R32 = open, } \mathrm{T} 1, \mathrm{~T} 2=\text { open } \end{aligned}$ |
| LO_IN SMA, R10, R11, R13, R15, R32, R34, R43, C40, T1, T2 | Optional single-ended LO input at LOIN. | $R 10, R 11, R 15, R 32, R 43=0 \Omega$, $\mathrm{R} 13, \mathrm{R} 34, \mathrm{C} 40=$ open, $\mathrm{T} 1, \mathrm{~T} 2=$ open |
| LO_IP SMA, LO_IN SMA, R10, R11, R13, R15, R32, R34, R43, C40, T1, T2 | Optional differential LO input. | $R 11, R 15, R 32, R 34, R 43, C 40=0 \Omega$, R10, R13 = open, T1, T2 = open |
| LO_IP SMA, R10, R11, R13, R15, R32, R34, R43, C40, T1, T2 | Optional differential LO driving with balun (T1or T2) at LOIP. | $\begin{aligned} & \text { R13, R34, C40 }=0 \Omega \text {, } \\ & \text { R10, R11, R15, R32, R43 = open, } \\ & \text { T1 = TC1-1-43A+, T2 = TC1-1-13M+ } \end{aligned}$ |
| C31 | AC-coupling capacitor connects ADL5385 VOUT to RF_OUT RF connector or to ADL5601 RF input. | $\mathrm{C} 31=0.1 \mu \mathrm{~F}$ |
| C47 | AC-coupling capacitor connects ADL5601 RFOUT to AMP_OUT connector. | $\mathrm{C} 47=0.1 \mu \mathrm{~F}$ |
| R40 | Resistor connects ADL5385 VOUT to RF_OUT SMA. To check ADL5385 performance itself, insert a $0 \Omega$ at R40 and open R25. To check ADL5601 performance itself, insert a $0 \Omega$ at R40 and be inserted $0.1 \mu \mathrm{~F}$ on R25, open C31. | $R 40=$ open |
| R25 | Resistor connects ADL5385 VOUT to ADL5601 RFIN. | $\mathrm{R} 25=0 \Omega$ |
| RTEMP | Resistor connects ADL5385 TEMP to TEMP test clip lead. | RTEMP $=200 \Omega$ |
| L8 | DC bias inductor. | L8 $=470 \mathrm{nH}$ |
| $\begin{aligned} & \text { C3, C4, C5, C6, C8, C9, C11, } \\ & \text { C43, C44, C45 } \end{aligned}$ | Power supply bypassing capacitors. | $\begin{aligned} & \mathrm{C} 3=10 \mu \mathrm{~F} \\ & \mathrm{C} 4, \mathrm{C} 6, \mathrm{C} 8=0.1 \mu \mathrm{~F}, \mathrm{C} 5, \mathrm{C} 9, \mathrm{C} 11=100 \mathrm{pF} \\ & \mathrm{C} 43=1 \mu \mathrm{~F}, \mathrm{C} 44=1.2 \mathrm{nF}, \mathrm{C} 45=68 \mathrm{pF} \end{aligned}$ |
| R8 | Resistor to share power supply between the ADL5385 and the ADL5601. To turn on the ADL5601 with the power supply on VP1, install a $0 \Omega$ resistor in this location. | $\mathrm{R} 8=\mathrm{open}$ |
| U1 | ADL5385 quadrature modulator. | ADL5385 |
| U2 | SOT-89 RF/IF gain block. | ADL5601 |



Figure 44. Layout of ADL5385-DIFFLO-EBZ, Top View


Figure 45. Layout of ADL5385-DIFFLO-EBZ, Bottom View

## CHARACTERIZATION SETUP

SSB SETUP
Figure 46 is a diagram of the characterization test stand setup for the ADL5385, which is intended to test the product as a single-sideband modulator. The Aeroflex IFR3416 signal generator provides the $I$ and $Q$ inputs as well as the LO input.

Output signals are measured directly using the spectrum analyzer, and currents and voltages are measured using the Agilent 34401A multimeter.


Figure 46. ADL5385 Characterization Board SSB Test Setup

## ADL5385

## OUTLINE DIMENSIONS



ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Description | Package Option | Ordering Quantity |
| :--- | :--- | :--- | :--- | :--- |
| ADL5385ACPZ-WP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 24-Lead LFCSP, Waffle Pack | $\mathrm{CP}-24-14$ | 64 |
| ADL5385ACPZ-R7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 24-Lead LFCSP, 7"Tape and Reel | CP-24-14 | 1500 |
| ADL5385-DIFFLO-EBZ |  | Evaluation Board with Differential LO Input |  | 1 |

[^0]
[^0]:    ${ }^{1} \mathrm{Z}=$ RoHS Compliant Part.

